

Welcome to **E-XFL.COM** 

# Understanding <u>Embedded - FPGAs (Field Programmable Gate Array)</u>

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

#### **Applications of Embedded - FPGAs**

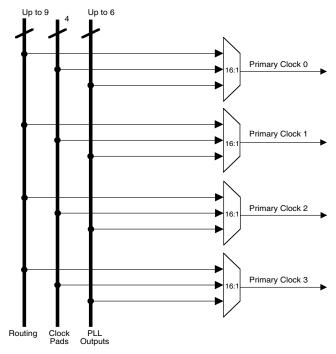
The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	80
Number of Logic Elements/Cells	640
Total RAM Bits	-
Number of I/O	159
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	256-BGA
Supplier Device Package	256-FPBGA (17x17)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lcmxo640e-5f256c

Email: info@E-XFL.COM

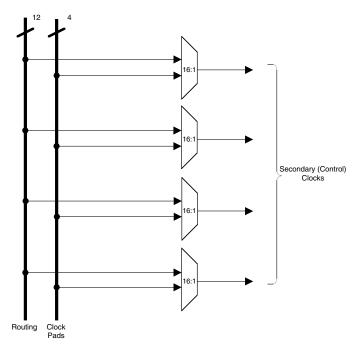
Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

Figure 2-8. Primary Clocks for MachXO1200 and MachXO2280 Devices



Four secondary clocks are generated from four 16:1 muxes as shown in Figure 2-9. Four of the secondary clock sources come from dual function clock pins and 12 come from internal routing.

Figure 2-9. Secondary Clocks for MachXO Devices





The EBR memory supports three forms of write behavior for single or dual port operation:

- 1. **Normal** data on the output appears only during the read cycle. During a write cycle, the data (at the current address) does not appear on the output. This mode is supported for all data widths.
- 2. **Write Through** a copy of the input data appears at the output of the same port. This mode is supported for all data widths.
- 3. **Read-Before-Write** when new data is being written, the old contents of the address appears at the output. This mode is supported for x9, x18 and x36 data widths.

#### **FIFO Configuration**

The FIFO has a write port with Data-in, CEW, WE and CLKW signals. There is a separate read port with Data-out, RCE, RE and CLKR signals. The FIFO internally generates Almost Full, Full, Almost Empty and Empty Flags. The Full and Almost Full flags are registered with CLKW. The Empty and Almost Empty flags are registered with CLKR. The range of programming values for these flags are in Table 2-7.

Table 2-7. Programmable FIFO Flag Ranges

Flag Name	Programming Range
Full (FF)	1 to (up to 2 <sup>N</sup> -1)
Almost Full (AF)	1 to Full-1
Almost Empty (AE)	1 to Full-1
Empty (EF)	0

N = Address bit width

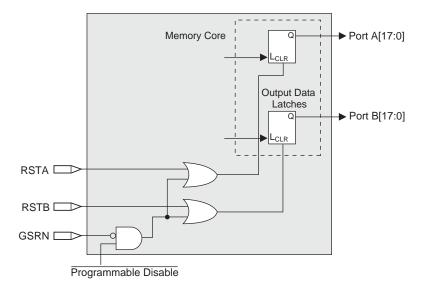
The FIFO state machine supports two types of reset signals: RSTA and RSTB. The RSTA signal is a global reset that clears the contents of the FIFO by resetting the read/write pointer and puts the FIFO flags in their initial reset state. The RSTB signal is used to reset the read pointer. The purpose of this reset is to retransmit the data that is in the FIFO. In these applications it is important to keep careful track of when a packet is written into or read from the FIFO.

#### **Memory Core Reset**

The memory array in the EBR utilizes latches at the A and B output ports. These latches can be reset asynchronously. RSTA and RSTB are local signals, which reset the output latches associated with Port A and Port B respectively. The Global Reset (GSRN) signal resets both ports. The output data latches and associated resets for both ports are as shown in Figure 2-13.



Figure 2-13. Memory Core Reset

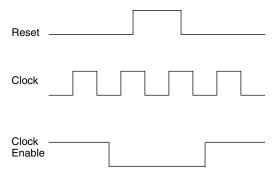


For further information on the sysMEM EBR block, see the details of additional technical documentation at the end of this data sheet.

#### **EBR Asynchronous Reset**

EBR asynchronous reset or GSR (if used) can only be applied if all clock enables are low for a clock cycle before the reset is applied and released a clock cycle after the reset is released, as shown in Figure 2-14. The GSR input to the EBR is always asynchronous.

Figure 2-14. EBR Asynchronous Reset (Including GSR) Timing Diagram



If all clock enables remain enabled, the EBR asynchronous reset or GSR may only be applied and released after the EBR read and write clock inputs are in a steady state condition for a minimum of 1/f<sub>MAX</sub> (EBR clock). The reset release must adhere to the EBR synchronous reset setup time before the next active read or write clock edge.

If an EBR is pre-loaded during configuration, the GSR input must be disabled or the release of the GSR during device Wake Up must occur before the release of the device I/Os becoming active.

These instructions apply to all EBR RAM, ROM and FIFO implementations. For the EBR FIFO mode, the GSR signal is always enabled and the WE and RE signals act like the clock enable signals in Figure 2-14. The reset timing rules apply to the RPReset input vs the RE input and the RST input vs. the WE and RE inputs. Both RST and RPReset are always asynchronous EBR inputs.

Note that there are no reset restrictions if the EBR synchronous reset is used and the EBR GSR input is disabled



Figure 2-20. MachXO640 Banks

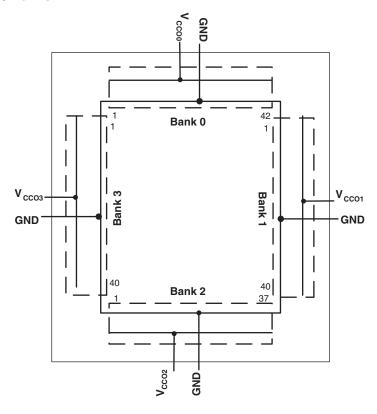
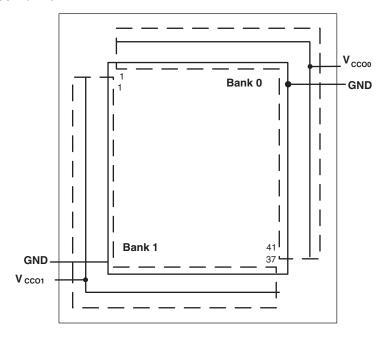


Figure 2-21. MachXO256 Banks



## **Hot Socketing**

The MachXO devices have been carefully designed to ensure predictable behavior during power-up and power-down. Leakage into I/O pins is controlled to within specified limits. This allows for easy integration with the rest of



the system. These capabilities make the MachXO ideal for many multiple power supply and hot-swap applications.

### **Sleep Mode**

The MachXO "C" devices ( $V_{CC} = 1.8/2.5/3.3V$ ) have a sleep mode that allows standby current to be reduced dramatically during periods of system inactivity. Entry and exit to Sleep mode is controlled by the SLEEPN pin.

During Sleep mode, the logic is non-operational, registers and EBR contents are not maintained, and I/Os are tristated. Do not enter Sleep mode during device programming or configuration operation. In Sleep mode, power supplies are in their normal operating range, eliminating the need for external switching of power supplies. Table 2-11 compares the characteristics of Normal, Off and Sleep modes.

Table 2-11. Characteristics of Normal, Off and Sleep Modes

Characteristic	Normal	Off	Sleep
SLEEPN Pin	High	_	Low
Static Icc	Typical <10mA	0	Typical <100uA
I/O Leakage	<10μΑ	<1mA	<10μΑ
Power Supplies VCC/VCCIO/VCCAUX	Normal Range	0	Normal Range
Logic Operation	User Defined	Non Operational	Non operational
I/O Operation	User Defined	Tri-state	Tri-state
JTAG and Programming circuitry	Operational	Non-operational	Non-operational
EBR Contents and Registers	Maintained	Non-maintained	Non-maintained

#### **SLEEPN Pin Characteristics**

The SLEEPN pin behaves as an LVCMOS input with the voltage standard appropriate to the VCC supply for the device. This pin also has a weak pull-up, along with a Schmidt trigger and glitch filter to prevent false triggering. An external pull-up to VCC is recommended when Sleep Mode is not used to ensure the device stays in normal operation mode. Typically, the device enters sleep mode several hundred nanoseconds after SLEEPN is held at a valid low and restarts normal operation as specified in the Sleep Mode Timing table. The AC and DC specifications portion of this data sheet shows a detailed timing diagram.

#### **Oscillator**

Every MachXO device has an internal CMOS oscillator. The oscillator can be routed as an input clock to the clock tree or to general routing resources. The oscillator frequency can be divided by internal logic. There is a dedicated programming bit to enable/disable the oscillator. The oscillator frequency ranges from 18MHz to 26MHz.

## **Configuration and Testing**

The following section describes the configuration and testing features of the MachXO family of devices.

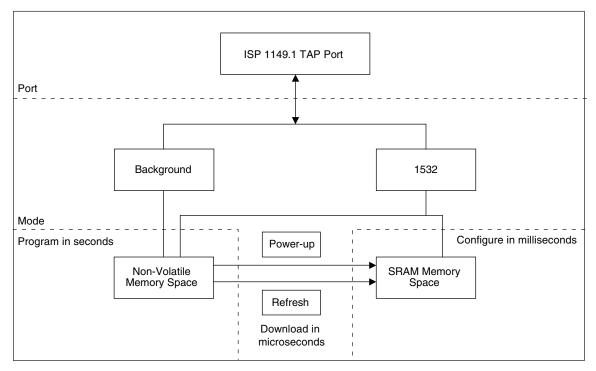
#### IEEE 1149.1-Compliant Boundary Scan Testability

All MachXO devices have boundary scan cells that are accessed through an IEEE 1149.1 compliant test access port (TAP). This allows functional testing of the circuit board, on which the device is mounted, through a serial scan path that can access all critical logic nodes. Internal registers are linked internally, allowing test data to be shifted in and loaded directly onto test nodes, or test data to be captured and shifted out for verification. The test access port consists of dedicated I/Os: TDI, TDO, TCK and TMS. The test access port shares its power supply with one of the VCCIO Banks (MachXO256: V<sub>CCIO1</sub>; MachXO640: V<sub>CCIO2</sub>; MachXO1200 and MachXO2280: V<sub>CCIO5</sub>) and can operate with LVCMOS3.3, 2.5, 1.8, 1.5, and 1.2 standards.

For more details on boundary scan test, please see information regarding additional technical documentation at the end of this data sheet.



Figure 2-22. MachXO Configuration and Programming



## **Density Shifting**

The MachXO family has been designed to enable density migration in the same package. Furthermore, the architecture ensures a high success rate when performing design migration from lower density parts to higher density parts. In many cases, it is also possible to shift a lower utilization design targeted for a high-density device to a lower density device. However, the exact details of the final resource utilization will impact the likely success in each case.



## MachXO256 and MachXO640 Hot Socketing Specifications<sup>1, 2, 3</sup>

Symbol	Parameter	Condition	Min.	Тур.	Max	Units
$I_{DK}$	Input or I/O leakage Current	$0 \le V_{IN} \le V_{IH} (MAX)$	-		+/-1000	μΑ

- 1. Insensitive to sequence of V<sub>CC,</sub> V<sub>CCAUX,</sub> and V<sub>CCIO</sub>. However, assumes monotonic rise/fall rates for V<sub>CC,</sub> V<sub>CCAUX,</sub> and V<sub>CCIO.</sub>
- $2. \ \ 0 \leq V_{CC} \leq V_{CC} \ (\text{MAX}), \ 0 \leq V_{CCIO} \leq V_{CCIO} \ (\text{MAX}) \ \text{and} \ 0 \leq V_{CCAUX} \leq V_{CCAUX} \ (\text{MAX}).$
- 3.  $I_{DK}$  is additive to  $I_{PU}$   $I_{PD}$  or  $I_{BH}$ .

## MachXO1200 and MachXO2280 Hot Socketing Specifications<sup>1, 2, 3</sup>

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units			
Non-LVDS General Purpose syslOs									
I <sub>DK</sub>	Input or I/O Leakage Current	$0 \le V_{IN} \le V_{IH}$ (MAX.)	_	_	+/-1000	μΑ			
LVDS Gener	al Purpose syslOs	•							
1	Input or I/O Leakage Current	$V_{IN} \le V_{CCIO}$	_	_	+/-1000	μΑ			
DK_LVDS	input of 1/O Leakage Current	V <sub>IN</sub> > V <sub>CCIO</sub>	_	35	_	mA			

- 1. Insensitive to sequence of  $V_{CC,}$   $V_{CCAUX,}$  and  $V_{CCIO}$ . However, assumes monotonic rise/fall rates for  $V_{CC,}$   $V_{CCAUX,}$  and  $V_{CCIO,}$
- 2.  $0 \le V_{CC} \le V_{CC}$  (MAX),  $0 \le V_{CCIO} \le V_{CCIO}$  (MAX), and  $0 \le V_{CCAUX} \le V_{CCAUX}$  (MAX).
- 3.  $I_{DK}$  is additive to  $I_{PU}$ ,  $I_{PW}$  or  $I_{BH}$ .

#### **DC Electrical Characteristics**

#### **Over Recommended Operating Conditions**

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
I <sub>IL,</sub> I <sub>IH</sub> <sup>1, 4, 5</sup>	Input or I/O Leakage	$0 \le V_{IN} \le (V_{CCIO} - 0.2V)$	_	_	10	μΑ
'IL, 'IH	linput of 1/O Leakage	$(V_{CCIO} - 0.2V) < V_{IN} \le 3.6V$	_		40	μΑ
I <sub>PU</sub>	I/O Active Pull-up Current	$0 \le V_{IN} \le 0.7 \ V_{CCIO}$	-30		-150	μΑ
I <sub>PD</sub>	I/O Active Pull-down Current	$V_{IL}$ (MAX) $\leq V_{IN} \leq V_{IH}$ (MAX)	30		150	μΑ
I <sub>BHLS</sub>	Bus Hold Low sustaining current	$V_{IN} = V_{IL} (MAX)$	30		_	μΑ
I <sub>BHHS</sub>	Bus Hold High sustaining current	$V_{IN} = 0.7V_{CCIO}$	-30		_	μΑ
I <sub>BHLO</sub>	Bus Hold Low Overdrive current	$0 \le V_{IN} \le V_{IH} (MAX)$	_		150	μΑ
Івнно	Bus Hold High Overdrive current	$0 \le V_{IN} \le V_{IH} (MAX)$	_		-150	μΑ
V <sub>BHT</sub> <sup>3</sup>	Bus Hold trip Points	$0 \le V_{IN} \le V_{IH} (MAX)$	V <sub>IL</sub> (MAX)		V <sub>IH</sub> (MIN)	V
C1	I/O Capacitance <sup>2</sup>	$V_{CCIO} = 3.3V, 2.5V, 1.8V, 1.5V, 1.2V, V_{CC} = Typ., V_{IO} = 0 to V_{IH} (MAX)$	_	8	_	pf
C2	Dedicated Input Capacitance <sup>2</sup>	$V_{CCIO} = 3.3V, 2.5V, 1.8V, 1.5V, 1.2V, V_{CC} = Typ., V_{IO} = 0 to V_{IH} (MAX)$	_	8	_	pf

<sup>1.</sup> Input or I/O leakage current is measured with the pin configured as an input or as an I/O with the output driver tri-stated. It is not measured with the output driver active. Bus maintenance circuits are disabled.

<sup>2.</sup>  $T_A$  25°C, f = 1.0MHz

<sup>3.</sup> Please refer to  $V_{IL}$  and  $V_{IH}$  in the sysIO Single-Ended DC Electrical Characteristics table of this document.

<sup>4.</sup> Not applicable to SLEEPN pin.

<sup>5.</sup> When  $V_{IH}$  is higher than  $V_{CCIO}$ , a transient current typically of 30ns in duration or less with a peak current of 6mA can occur on the high-to-low transition. For MachXO1200 and MachXO2280 true LVDS output pins,  $V_{IH}$  must be less than or equal to  $V_{CCIO}$ .



Table 3-2. BLVDS DC Conditions<sup>1</sup>

#### **Over Recommended Operating Conditions**

		Non		
Symbol	Description	Zo = 45	Zo = 90	Units
Z <sub>OUT</sub>	Output impedance	100	100	Ohms
R <sub>TLEFT</sub>	Left end termination	45	90	Ohms
R <sub>TRIGHT</sub>	Right end termination	45	90	Ohms
V <sub>OH</sub>	Output high voltage	1.375	1.48	V
V <sub>OL</sub>	Output low voltage	1.125	1.02	V
$V_{OD}$	Output differential voltage	0.25	0.46	V
V <sub>CM</sub>	Output common mode voltage	1.25	1.25	V
I <sub>DC</sub>	DC output current	11.2	10.2	mA

<sup>1.</sup> For input buffer, see LVDS table.

#### **LVPECL**

The MachXO family supports the differential LVPECL standard through emulation. This output standard is emulated using complementary LVCMOS outputs in conjunction with a parallel resistor across the driver outputs on all the devices. The LVPECL input standard is supported by the LVDS differential input buffer on certain devices. The scheme shown in Figure 3-3 is one possible solution for point-to-point signals.

Figure 3-3. Differential LVPECL

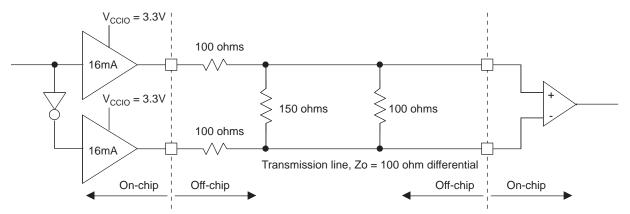


Table 3-3. LVPECL DC Conditions1

#### **Over Recommended Operating Conditions**

Symbol	Description	Nominal	Units
Z <sub>OUT</sub>	Output impedance	100	Ohms
R <sub>P</sub>	Driver parallel resistor	150	Ohms
R <sub>T</sub>	Receiver termination	100	Ohms
V <sub>OH</sub>	Output high voltage	2.03	V
V <sub>OL</sub>	Output low voltage	1.27	V
V <sub>OD</sub>	Output differential voltage	0.76	V
V <sub>CM</sub>	Output common mode voltage	1.65	V
Z <sub>BACK</sub>	Back impedance	85.7	Ohms
I <sub>DC</sub>	DC output current	12.7	mA

<sup>1.</sup> For input buffer, see LVDS table.



# MachXO Family Data Sheet Pinout Information

June 2013 Data Sheet DS1002

## **Signal Descriptions**

Signal Name	I/O	Descriptions
General Purpose		
		[Edge] indicates the edge of the device on which the pad is located. Valid edge designations are L (Left), B (Bottom), R (Right), T (Top).
		[Row/Column Number] indicates the PFU row or the column of the device on which the PIO Group exists. When Edge is T (Top) or (Bottom), only need to specify Row Number. When Edge is L (Left) or R (Right), only need to specify Column Number.
P[Edge] [Row/Column	I/O	[A/B/C/D/E/F] indicates the PIO within the group to which the pad is connected.
Number]_[A/B/C/D/E/F]	,, 0	Some of these user programmable pins are shared with special function pins. When not used as special function pins, these pins can be programmed as I/Os for user logic.
		During configuration of the user-programmable I/Os, the user has an option to tri-state the I/Os and enable an internal pull-up resistor. This option also applies to unused pins (or those not bonded to a package pin). The default during configuration is for user-programmable I/Os to be tri-stated with an internal pull-up resistor enabled. When the device is erased, I/Os will be tri-stated with an internal pull-up resistor enabled.
GSRN	I	Global RESET signal (active low). Dedicated pad, when not in use it can be used as an I/O pin.
TSALL	I	TSALL is a dedicated pad for the global output enable signal. When TSALL is high all the outputs are tristated. It is a dual function pin. When not in use, it can be used as an I/O pin.
NC	_	No connect.
GND	_	GND - Ground. Dedicated pins.
V <sub>CC</sub>	_	VCC - The power supply pins for core logic. Dedicated pins.
V <sub>CCAUX</sub>	_	VCCAUX - the Auxiliary power supply pin. This pin powers up a variety of internal circuits including all the differential and referenced input buffers. Dedicated pins.
V <sub>CCIOx</sub>	_	V <sub>CCIO</sub> - The power supply pins for I/O Bank x. Dedicated pins.
SLEEPN1	I	Sleep Mode pin - Active low sleep pin.b When this pin is held high, the device operates normally.b This pin has a weak internal pull-up, but when unused, an external pull-up to $V_{\rm CC}$ is recommended. When driven low, the device moves into Sleep mode after a specified time.
PLL and Clock Functions (	Used a	as user programmable I/O pins when not used for PLL or clock pins)
[LOC][0]_PLL[T, C]_IN	_	Reference clock (PLL) input Pads: [LOC] indicates location. Valid designations are ULM (Upper PLL) and LLM (Lower PLL). T = true and C = complement.
[LOC][0]_PLL[T, C]_FB	_	Optional feedback (PLL) input Pads: [LOC] indicates location. Valid designations are ULM (Upper PLL) and LLM (Lower PLL). T = true and C = complement.
PCLK [n]_[1:0]	_	Primary Clock Pads, n per side.
Test and Programming (De	dicate	d pins)
TMS	I	Test Mode Select input pin, used to control the 1149.1 state machine.
TCK	I	Test Clock input pin, used to clock the 1149.1 state machine.
TDI	I	Test Data input pin, used to load data into the device using an 1149.1 state machine.
TDO	0	Output pin -Test Data output pin used to shift data out of the device using 1149.1.

<sup>1.</sup> Applies to MachXO "C" devices only. NC for "E" devices.

© 2013 Lattice Semiconductor Corp. All Lattice trademarks, registered trademarks, patents, and disclaimers are as listed at www.latticesemi.com/legal. All other brand or product names are trademarks or registered trademarks of their respective holders. The specifications and information herein are subject to change without notice.

www.latticesemi.com 4-1 DS1002 Pinouts\_01.9



# LCMXO256 and LCMXO640 Logic Signal Connections: 100 TQFP (Cont.)

		LCMX	(O256		LCMXO640			
Pin Number	Ball Function	Bank	Dual Function	Differential	Ball Function	Bank	Dual Function	Differential
43	PB4A	1		Т	PB8B	2		
44	PB4B	1		С	PB8C	2		Т
45	PB4C	1		Т	PB8D	2		С
46	PB4D	1		С	PB9A	2		
47	PB5A	1			PB9C	2		Т
48*	SLEEPN	-	SLEEPN		SLEEPN	-	SLEEPN	
49	PB5C	1		Т	PB9D	2		С
50	PB5D	1		С	PB9F	2		
51	PR9B	0		С	PR11D	1		С
52	PR9A	0		Т	PR11B	1		С
53	PR8B	0		С	PR11C	1		Т
54	PR8A	0		Т	PR11A	1		Т
55	PR7D	0		С	PR10D	1		С
56	PR7C	0		Т	PR10C	1		Т
57	PR7B	0		С	PR10B	1		С
58	PR7A	0		Т	PR10A	1		Т
59	PR6B	0		С	PR9D	1		
60	VCCIO0	0			VCCIO1	1		
61	PR6A	0		Т	PR9B	1		
62	GNDIO0	0			GNDIO1	1		
63	PR5D	0		С	PR7B	1		
64	PR5C	0		Т	PR6C	1		
65	PR5B	0		С	PR6B	1		
66	PR5A	0		Т	PR5D	1		
67	PR4B	0		С	PR5B	1		
68	PR4A	0		Т	PR4D	1		
69	PR3D	0		С	PR4B	1		
70	PR3C	0		Т	PR3D	1		
71	PR3B	0		С	PR3B	1		
72	PR3A	0		Т	PR2D	1		
73	PR2B	0		С	PR2B	1		
74	VCCIO0	0			VCCIO1	1		
75	GNDIO0	0			GNDIO1	1		
76	PR2A	0		Т	PT9F	0		С
77	PT5C	0			PT9E	0		Т
78	PT5B	0		С	PT9C	0		
79	PT5A	0		Т	PT9A	0		
80	PT4F	0		С	VCCIO0	0		
81	PT4E	0		Т	GNDIO0	0		
82	PT4D	0		С	PT7E	0		
83	PT4C	0		Т	PT7A	0		
84	GND	-			GND	-		



# LCMXO640, LCMXO1200 and LCMXO2280 Logic Signal Connections: 144 TQFP

		CMXO640				LCMXO1200		LCMXO2280				
Pin Number	Ball Function	Bank	Dual Function	Differential	Ball Function	Bank	Dual Function	Differential	Ball Function	Bank	Dual Function	Differential
1	PL2A	3		Т	PL2A	7		Т	PL2A	7	LUM0_PLLT_FB_A	Т
2	PL2C	3		Т	PL2B	7		С	PL2B	7	LUM0_PLLC_FB_A	С
3	PL2B	3		С	PL3A	7		T*	PL3A	7		T*
4	PL3A	3		Т	PL3B	7		C*	PL3B	7		C*
5	PL2D	3		С	PL3C	7		Т	PL3C	7	LUM0_PLLT_IN_A	Т
6	PL3B	3		С	PL3D	7		С	PL3D	7	LUM0_PLLC_IN_A	С
7	PL3C	3		Т	PL4A	7		T*	PL4A	7		T*
8	PL3D	3		С	PL4B	7		C*	PL4B	7		C*
9	PL4A	3			PL4C	7			PL4C	7		
10	VCCIO3	3			VCCIO7	7			VCCIO7	7		
11	GNDIO3	3			GNDIO7	7			GNDIO7	7		
12	PL4D	3			PL5C	7			PL6C	7		
13	PL5A	3		Т	PL6A	7		T*	PL7A	7		T*
14	PL5B	3	GSRN	С	PL6B	7	GSRN	C*	PL7B	7	GSRN	C*
15	PL5D	3			PL6D	7			PL7D	7		
16	GND	-			GND	-			GND	-		
17	PL6C	3		Т	PL7C	7		Т	PL9C	7		Т
18	PL6D	3		С	PL7D	7		С	PL9D	7		С
19	PL7A	3		Т	PL10A	6		T*	PL13A	6		T*
20	PL7B	3		С	PL10B	6		C*	PL13B	6		C*
21	VCC	-			VCC	-			VCC	-		
22	PL8A	3		Т	PL11A	6		T*	PL13D	6		
23	PL8B	3		С	PL11B	6		C*	PL14D	6		С
24	PL8C	3	TSALL		PL11C	6	TSALL		PL14C	6	TSALL	Т
25	PL9C	3		Т	PL12B	6			PL15B	6		
26	VCCIO3	3			VCCIO6	6			VCCIO6	6		
27	GNDIO3	3			GNDIO6	6			GNDIO6	6		
28	PL9D	3		С	PL13D	6			PL16D	6		
29	PL10A	3		Т	PL14A	6	LLM0_PLLT_FB_A	T*	PL17A	6	LLM0_PLLT_FB_A	T*
30	PL10B	3		С	PL14B	6	LLM0_PLLC_FB_A	C*	PL17B	6	LLM0_PLLC_FB_A	C*
31	PL10C	3		Т	PL14C	6		Т	PL17C	6		Т
32	PL11A	3		Т	PL14D	6		С	PL17D	6		С
33	PL10D	3		С	PL15A	6	LLM0_PLLT_IN_A	T*	PL18A	6	LLM0_PLLT_IN_A	T*
34	PL11C	3		Т	PL15B	6	LLM0_PLLC_IN_A	C*	PL18B	6	LLM0_PLLC_IN_A	C*
35	PL11B	3		С	PL16A	6		Т	PL19A	6		Т
36	PL11D	3		С	PL16B	6		С	PL19B	6		С
37	GNDIO2	2			GNDIO5	5			GNDIO5	5		
38	VCCIO2	2			VCCIO5	5			VCCIO5	5		
39	TMS	2	TMS		TMS	5	TMS		TMS	5	TMS	
40	PB2C	2	-		PB2C	5	-	Т	PB2A	5	-	Т
41	PB3A	2		Т	PB2D	5		C	PB2B	5		C
42	TCK	2	TCK		TCK	5	TCK		TCK	5	TCK	-
43	PB3B	2		С	PB3A	5		Т	PB3A	5		Т
44	PB3C	2		T	PB3B	5		C	PB3B	5		C
45	PB3D	2		C	PB4A	5		T	PB4A	5		T
46	PB4A	2		T	PB4B	5		C	PB4B	5		C
47	TDO	2	TDO		TDO	5	TDO		TDO	5	TDO	
48	PB4B	2		С	PB4D	5			PB4D	5		
49	PB4C	2		T	PB5A	5		Т	PB5A	5		Т
50	PB4D	2		C	PB5B	5		C	PB5B	5		C



# LCMXO640, LCMXO1200 and LCMXO2280 Logic Signal Connections: 144 TQFP (Cont.)

		L	.CMXO640				LCMXO1200				LCMXO2280	
Pin Number	Ball Function	Bank	Dual Function	Differential	Ball Function	Bank	Dual Function	Differential	Ball Function	Bank	Dual Function	Differential
51	TDI	2	TDI		TDI	5	TDI		TDI	5	TDI	
52	VCC	-			VCC	-			VCC	-		
53	VCCAUX	-			VCCAUX	-			VCCAUX	-		
54	PB5A	2		Т	PB6F	5			PB8F	5		
55	PB5B	2	PCLKT2_1***	С	PB7B	4	PCLK4_1***		PB10F	4	PCLK4_1***	
56	PB5D	2			PB7C	4		Т	PB10C	4		Т
57	PB6A	2		Т	PB7D	4		С	PB10D	4		С
58	PB6B	2	PCLKT2_0***	С	PB7F	4	PCLK4_0***		PB10B	4	PCLK4_0***	
59	GND	-			GND	-			GND	-		
60	PB7C	2			PB9A	4		Т	PB12A	4		Т
61	PB7E	2			PB9B	4		С	PB12B	4		С
62	PB8A	2			PB9E	4			PB12E	4		
63	VCCIO2	2			VCCIO4	4			VCCIO4	4		
64	GNDIO2	2			GNDIO4	4			GNDIO4	4		
65	PB8C	2		T	PB10A	4		Т	PB13A	4		Т
66	PB8D	2		С	PB10B	4		С	PB13B	4		С
67	PB9A	2		Т	PB10C	4		Т	PB13C	4		Т
68	PB9C	2		Т	PB10D	4		С	PB13D	4		С
69	PB9B	2		С	PB10F	4			PB14D	4		
70**	SLEEPN	-	SLEEPN		SLEEPN	-	SLEEPN		SLEEPN	-	SLEEPN	
71	PB9D	2		С	PB11C	4		Т	PB16C	4		Т
72	PB9F	2			PB11D	4		С	PB16D	4		С
73	PR11D	1		С	PR16B	3		С	PR20B	3		С
74	PR11B	1		С	PR16A	3		Т	PR20A	3		Т
75	PR11C	1		Т	PR15B	3		C*	PR19B	3		С
76	PR10D	1		С	PR15A	3		T*	PR19A	3		Т
77	PR11A	1		Т	PR14D	3		С	PR17D	3		С
78	PR10B	1		С	PR14C	3		Т	PR17C	3		Т
79	PR10C	1		Т	PR14B	3		C*	PR17B	3		C*
80	PR10A	1		Т	PR14A	3		T*	PR17A	3		T*
81	PR9D	1			PR13D	3			PR16D	3		
82	VCCIO1	1			VCCIO3	3			VCCIO3	3		
83	GNDIO1	1			GNDIO3	3			GNDIO3	3		
84	PR9A	1			PR12B	3		C*	PR15B	3		C*
85	PR8C	1			PR12A	3		T*	PR15A	3		T*
86	PR8A	1			PR11B	3		C*	PR14B	3		C*
87	PR7D	1			PR11A	3		T*	PR14A	3		T*
88	GND	-			GND	-			GND	-		
89	PR7B	1		С	PR10B	3		C*	PR13B	3		C*
90	PR7A	1		T	PR10A	3		T*	PR13A	3		T*
91	PR6D	1		C	PR8B	2		C*	PR10B	2		C*
92	PR6C	1		T	PR8A	2		T*	PR10A	2		T*
93	VCC	-		<u> </u>	VCC	-		<u>'</u>	VCC	-		+ '
94	PR5D	1			PR6B	2		C*	PR8B	2		C*
95	PR5B	1			PR6A	2		T*	PR8A	2		T*
96	PR4D	1			PR5B	2		C*	PR7B	2		C*
97	PR4B	1		С	PR5A	2		T*	PR7A	2		T*
98	VCCIO1	1			VCCIO2	2		<u>'</u>	VCCIO2	2		- '
98	GNDIO1	1			GNDIO2	2			GNDIO2	2		
		ļ	1	Т								
100	PR4A	1		'	PR4C	2			PR5C	2		



# LCMXO2280 Logic Signal Connections: 324 ftBGA

LCMXO2280								
Ball Number	Ball Function	Bank	Dual Function	Differential				
GND	GNDIO7	7						
VCCIO7	VCCIO7	7						
D4	PL2A	7	LUM0_PLLT_FB_A	Т				
F5	PL2B	7	LUM0_PLLC_FB_A	С				
B3	PL3A	7		T*				
C3	PL3B	7		C*				
E4	PL3C	7	LUM0_PLLT_IN_A	Т				
G6	PL3D	7	LUM0_PLLC_IN_A	С				
A1	PL4A	7		T*				
B1	PL4B	7		C*				
F4	PL4C	7		Т				
VCC	VCC	-						
E3	PL4D	7		С				
D2	PL5A	7		T*				
D3	PL5B	7		C*				
G5	PL5C	7		Т				
F3	PL5D	7		С				
C2	PL6A	7		T*				
VCCIO7	VCCIO7	7						
GND	GNDIO7	7						
C1	PL6B	7		C*				
H5	PL6C	7		Т				
G4	PL6D	7		С				
E2	PL7A	7		T*				
D1	PL7B	7	GSRN	C*				
J6	PL7C	7		Т				
H4	PL7D	7		С				
F2	PL8A	7		T*				
E1	PL8B	7		C*				
GND	GND	-						
J3	PL8C	7		Т				
J5	PL8D	7		С				
G3	PL9A	7		T*				
H3	PL9B	7		C*				
K3	PL9C	7		Т				
K5	PL9D	7		С				
F1	PL10A	7		T*				
VCCIO7	VCCIO7	7						
GND	GNDIO7	7						
G1	PL10B	7		C*				
K4	PL10C	7		Т				
K6	PL10D	7	+	С				



# LCMXO2280 Logic Signal Connections: 324 ftBGA (Cont.)

LCMXO2280								
Ball Number	Ball Function	Bank	Dual Function	Differential				
T2	PL20B	6		С				
P6	TMS	5	TMS					
V1	PB2A	5		Т				
U2	PB2B	5		С				
T3	PB2C	5		Т				
N7	TCK	5	TCK					
R4	PB2D	5		С				
R5	PB3A	5		Т				
T4	PB3B	5		С				
VCC	VCC	-						
R6	PB3C	5		Т				
P7	PB3D	5		С				
U3	PB4A	5		Т				
T5	PB4B	5		С				
V2	PB4C	5		Т				
N8	TDO	5	TDO					
V3	PB4D	5		С				
T6	PB5A	5		Т				
GND	GNDIO5	5						
VCCIO5	VCCIO5	5						
U4	PB5B	5		С				
P8	PB5C	5		Т				
T7	PB5D	5		С				
V4	TDI	5	TDI					
R8	PB6A	5		Т				
N9	PB6B	5		С				
U5	PB6C	5		Т				
V5	PB6D	5		С				
U6	PB7A	5		Т				
VCC	VCC	-						
V6	PB7B	5		С				
P9	PB7C	5		T				
T8	PB7D	5		С				
U7	PB8A	5		T				
V7	PB8B	5		С				
M10	VCCAUX	-						
U8	PB8C	5		T				
V8	PB8D	5		C				
VCCIO5	VCCIO5	5		<del>-</del>				
GND	GNDIO5	5						
T9	PB8E	5		T				
U9	PB8F	5		C				
V9	PB9A	4		T				



# LCMXO2280 Logic Signal Connections: 324 ftBGA (Cont.)

LCMXO2280								
Ball Function	Bank	Dual Function	Differential					
GNDIO3	3							
VCCIO3	3							
PR20B	3		С					
PR20A	3		Т					
PR19B	3		С					
PR19A	3		Т					
PR18B	3		C*					
PR18A	3		T*					
PR17D	3		С					
PR17C	3		Т					
PR17B	3		C*					
VCC	-							
PR17A	3		T*					
PR16D	3		С					
PR16C	3		Т					
PR16B	3		C*					
VCCIO3	3							
GNDIO3	3							
PR16A	3		T*					
	3		С					
			Т					
			C*					
			T*					
			С					
			Т					
			C*					
			T*					
	-							
	3		С					
			Т					
			C*					
			 C					
			T					
			C*					
			•					
			С					
			T					
			C*					
			C					
	GNDIO3  VCCIO3  PR20B  PR20A  PR19B  PR19A  PR18B  PR18A  PR17D  PR17C  PR17B  VCC  PR17A  PR16D  PR16C  PR16B  VCCIO3	GNDIO3 3 VCCIO3 3 PR20B 3 PR20A 3 PR19B 3 PR19A 3 PR18B 3 PR18A 3 PR17C 3 PR17C 3 PR17B 3 VCC - PR17A 3 PR16D 3 PR16C 3 PR16B 3 VCCIO3 3 GNDIO3 3 PR16A 3 PR15D 3 PR15C 3 PR15B 3 PR15C 3 PR15B 3 PR15C 3 PR15B 3 PR15A 3 PR14D 3 PR14C 3 PR14D 3 PR14C 3 PR14B 3 PR14A 3 GND - PR13D 3 PR13C 3 PR13B 3 PR13C 3 PR13B 3 PR12C 3 PR12B 3 PR12A 3 GNDIO3 3 PR12A 3 PR12A 3 GNDIO3 3 PR12A 3 PR12B 3 PR12A 3 PR12A 3 PR12B 3 PR12A 3 PR12C 3 PR12B 3 PR12A 3 PR11D 3 PR11D 3	GNDIO3 3 VCCIO3 3 PR20B 3 PR20A 3 PR19B 3 PR19B 3 PR19B 3 PR19B 3 PR18A 3 PR17D 3 PR17C 3 PR17C 3 PR17B 3 VCC - PR17A 3 PR16C 3 PR16B 3 VCCIO3 3 GNDIO3 3 GNDIO3 3 PR15C 3 PR15B 3 PR15A 3 PR15B 3 PR15A 3 PR14D 3 PR14C 3 PR14D 3 PR14C 3 PR14B 3 PR14C 3 PR1					



# LCMXO2280 Logic Signal Connections: 324 ftBGA (Cont.)

LCMXO2280								
Ball Number	Ball Function	Bank	Dual Function	Differential				
F16	GND	-						
H10	GND	-						
H11	GND	-						
H8	GND	-						
H9	GND	-						
J10	GND	-						
J11	GND	-						
J4	GND	-						
J8	GND	-						
J9	GND	-						
K10	GND	-						
K11	GND	-						
K17	GND	-						
K8	GND	-						
K9	GND	-						
L10	GND	-						
L11	GND	-						
L8	GND	-						
L9	GND	-						
N2	GND	-						
P14	GND	-						
P5	GND	-						
R7	GND	-						
F14	VCC	-						
G11	VCC	-						
G9	VCC	-						
H7	VCC	-						
L7	VCC	-						
M9	VCC	-						
H6	VCCIO7	7						
J7	VCCIO7	7						
M7	VCCIO6	6						
K7	VCCIO6	6						
M8	VCCIO5	5						
R9	VCCIO5	5						
M12	VCCIO4	4						
M11	VCCIO4	4						
L12	VCCIO3	3						
K12	VCCIO3	3						
J12	VCCIO2	2						
H12	VCCIO2	2						
G12	VCCIO1	1						
G10	VCCIO1	<u>·</u> 1						



### **Thermal Management**

Thermal management is recommended as part of any sound FPGA design methodology. To assess the thermal characteristics of a system, Lattice specifies a maximum allowable junction temperature in all device data sheets. Designers must complete a thermal analysis of their specific design to ensure that the device and package do not exceed the junction temperature limits. Refer to the <a href="Thermal Management">Thermal Management</a> document to find the device/package specific thermal values.

#### For Further Information

For further information regarding Thermal Management, refer to the following:

- Thermal Management document
- TN1090 Power Estimation and Management for MachXO Devices
- Power Calculator tool included with the Lattice ispLEVER design tool, or as a standalone download from www.latticesemi.com/software



## **Conventional Packaging**

#### Commercial

Part Number	LUTs	Supply Voltage	I/Os	Grade	Package	Pins	Temp.
LCMXO256C-3T100C	256	1.8V/2.5V/3.3V	78	-3	TQFP	100	COM
LCMXO256C-4T100C	256	1.8V/2.5V/3.3V	78	-4	TQFP	100	COM
LCMXO256C-5T100C	256	1.8V/2.5V/3.3V	78	-5	TQFP	100	COM
LCMXO256C-3M100C	256	1.8V/2.5V/3.3V	78	-3	csBGA	100	COM
LCMXO256C-4M100C	256	1.8V/2.5V/3.3V	78	-4	csBGA	100	COM
LCMXO256C-5M100C	256	1.8V/2.5V/3.3V	78	-5	csBGA	100	COM

Part Number	LUTs	Supply Voltage	I/Os	Grade	Package	Pins	Temp.
LCMXO640C-3T100C	640	1.8V/2.5V/3.3V	74	-3	TQFP	100	COM
LCMXO640C-4T100C	640	1.8V/2.5V/3.3V	74	-4	TQFP	100	COM
LCMXO640C-5T100C	640	1.8V/2.5V/3.3V	74	-5	TQFP	100	COM
LCMXO640C-3M100C	640	1.8V/2.5V/3.3V	74	-3	csBGA	100	COM
LCMXO640C-4M100C	640	1.8V/2.5V/3.3V	74	-4	csBGA	100	COM
LCMXO640C-5M100C	640	1.8V/2.5V/3.3V	74	-5	csBGA	100	COM
LCMXO640C-3T144C	640	1.8V/2.5V/3.3V	113	-3	TQFP	144	COM
LCMXO640C-4T144C	640	1.8V/2.5V/3.3V	113	-4	TQFP	144	COM
LCMXO640C-5T144C	640	1.8V/2.5V/3.3V	113	-5	TQFP	144	COM
LCMXO640C-3M132C	640	1.8V/2.5V/3.3V	101	-3	csBGA	132	COM
LCMXO640C-4M132C	640	1.8V/2.5V/3.3V	101	-4	csBGA	132	COM
LCMXO640C-5M132C	640	1.8V/2.5V/3.3V	101	-5	csBGA	132	COM
LCMXO640C-3B256C	640	1.8V/2.5V/3.3V	159	-3	caBGA	256	COM
LCMXO640C-4B256C	640	1.8V/2.5V/3.3V	159	-4	caBGA	256	COM
LCMXO640C-5B256C	640	1.8V/2.5V/3.3V	159	-5	caBGA	256	COM
LCMXO640C-3FT256C	640	1.8V/2.5V/3.3V	159	-3	ftBGA	256	COM
LCMXO640C-4FT256C	640	1.8V/2.5V/3.3V	159	-4	ftBGA	256	COM
LCMXO640C-5FT256C	640	1.8V/2.5V/3.3V	159	-5	ftBGA	256	COM

Part Number	LUTs	Supply Voltage	I/Os	Grade	Package	Pins	Temp.
LCMXO1200C-3T100C	1200	1.8V/2.5V/3.3V	73	-3	TQFP	100	COM
LCMXO1200C-4T100C	1200	1.8V/2.5V/3.3V	73	-4	TQFP	100	COM
LCMXO1200C-5T100C	1200	1.8V/2.5V/3.3V	73	-5	TQFP	100	COM
LCMXO1200C-3T144C	1200	1.8V/2.5V/3.3V	113	-3	TQFP	144	COM
LCMXO1200C-4T144C	1200	1.8V/2.5V/3.3V	113	-4	TQFP	144	COM
LCMXO1200C-5T144C	1200	1.8V/2.5V/3.3V	113	-5	TQFP	144	COM
LCMXO1200C-3M132C	1200	1.8V/2.5V/3.3V	101	-3	csBGA	132	COM
LCMXO1200C-4M132C	1200	1.8V/2.5V/3.3V	101	-4	csBGA	132	COM
LCMXO1200C-5M132C	1200	1.8V/2.5V/3.3V	101	-5	csBGA	132	COM
LCMXO1200C-3B256C	1200	1.8V/2.5V/3.3V	211	-3	caBGA	256	COM
LCMXO1200C-4B256C	1200	1.8V/2.5V/3.3V	211	-4	caBGA	256	COM
LCMXO1200C-5B256C	1200	1.8V/2.5V/3.3V	211	-5	caBGA	256	COM
LCMXO1200C-3FT256C	1200	1.8V/2.5V/3.3V	211	-3	ftBGA	256	COM
LCMXO1200C-4FT256C	1200	1.8V/2.5V/3.3V	211	-4	ftBGA	256	COM
LCMXO1200C-5FT256C	1200	1.8V/2.5V/3.3V	211	-5	ftBGA	256	COM



# **Lead-Free Packaging**

### Commercial

Part Number	LUTs	Supply Voltage	I/Os	Grade	Package	Pins	Temp.
LCMXO256C-3TN100C	256	1.8V/2.5V/3.3V	78	-3	Lead-Free TQFP	100	COM
LCMXO256C-4TN100C	256	1.8V/2.5V/3.3V	78	-4	Lead-Free TQFP	100	COM
LCMXO256C-5TN100C	256	1.8V/2.5V/3.3V	78	-5	Lead-Free TQFP	100	COM
LCMXO256C-3MN100C	256	1.8V/2.5V/3.3V	78	-3	Lead-Free csBGA	100	COM
LCMXO256C-4MN100C	256	1.8V/2.5V/3.3V	78	-4	Lead-Free csBGA	100	COM
LCMXO256C-5MN100C	256	1.8V/2.5V/3.3V	78	-5	Lead-Free csBGA	100	COM

Part Number	LUTs	Supply Voltage	I/Os	Grade	Package	Pins	Temp.
LCMXO640C-3TN100C	640	1.8V/2.5V/3.3V	74	-3	Lead-Free TQFP	100	COM
LCMXO640C-4TN100C	640	1.8V/2.5V/3.3V	74	-4	Lead-Free TQFP	100	COM
LCMXO640C-5TN100C	640	1.8V/2.5V/3.3V	74	-5	Lead-Free TQFP	100	COM
LCMXO640C-3MN100C	640	1.8V/2.5V/3.3V	74	-3	Lead-Free csBGA	100	COM
LCMXO640C-4MN100C	640	1.8V/2.5V/3.3V	74	-4	Lead-Free csBGA	100	COM
LCMXO640C-5MN100C	640	1.8V/2.5V/3.3V	74	-5	Lead-Free csBGA	100	COM
LCMXO640C-3TN144C	640	1.8V/2.5V/3.3V	113	-3	Lead-Free TQFP	144	COM
LCMXO640C-4TN144C	640	1.8V/2.5V/3.3V	113	-4	Lead-Free TQFP	144	COM
LCMXO640C-5TN144C	640	1.8V/2.5V/3.3V	113	-5	Lead-Free TQFP	144	COM
LCMXO640C-3MN132C	640	1.8V/2.5V/3.3V	101	-3	Lead-Free csBGA	132	COM
LCMXO640C-4MN132C	640	1.8V/2.5V/3.3V	101	-4	Lead-Free csBGA	132	COM
LCMXO640C-5MN132C	640	1.8V/2.5V/3.3V	101	-5	Lead-Free csBGA	132	COM
LCMXO640C-3BN256C	640	1.8V/2.5V/3.3V	159	-3	Lead-Free caBGA	256	COM
LCMXO640C-4BN256C	640	1.8V/2.5V/3.3V	159	-4	Lead-Free caBGA	256	COM
LCMXO640C-5BN256C	640	1.8V/2.5V/3.3V	159	-5	Lead-Free caBGA	256	COM
LCMXO640C-3FTN256C	640	1.8V/2.5V/3.3V	159	-3	Lead-Free ftBGA	256	COM
LCMXO640C-4FTN256C	640	1.8V/2.5V/3.3V	159	-4	Lead-Free ftBGA	256	COM
LCMXO640C-5FTN256C	640	1.8V/2.5V/3.3V	159	-5	Lead-Free ftBGA	256	COM

Part Number	LUTs	Supply Voltage	I/Os	Grade	Package	Pins	Temp.
LCMXO1200C-3TN100C	1200	1.8V/2.5V/3.3V	73	-3	Lead-Free TQFP	100	COM
LCMXO1200C-4TN100C	1200	1.8V/2.5V/3.3V	73	-4	Lead-Free TQFP	100	COM
LCMXO1200C-5TN100C	1200	1.8V/2.5V/3.3V	73	-5	Lead-Free TQFP	100	COM
LCMXO1200C-3TN144C	1200	1.8V/2.5V/3.3V	113	-3	Lead-Free TQFP	144	COM
LCMXO1200C-4TN144C	1200	1.8V/2.5V/3.3V	113	-4	Lead-Free TQFP	144	COM
LCMXO1200C-5TN144C	1200	1.8V/2.5V/3.3V	113	-5	Lead-Free TQFP	144	COM
LCMXO1200C-3MN132C	1200	1.8V/2.5V/3.3V	101	-3	Lead-Free csBGA	132	COM
LCMXO1200C-4MN132C	1200	1.8V/2.5V/3.3V	101	-4	Lead-Free csBGA	132	COM
LCMXO1200C-5MN132C	1200	1.8V/2.5V/3.3V	101	-5	Lead-Free csBGA	132	COM
LCMXO1200C-3BN256C	1200	1.8V/2.5V/3.3V	211	-3	Lead-Free caBGA	256	COM
LCMXO1200C-4BN256C	1200	1.8V/2.5V/3.3V	211	-4	Lead-Free caBGA	256	COM
LCMXO1200C-5BN256C	1200	1.8V/2.5V/3.3V	211	-5	Lead-Free caBGA	256	COM
LCMXO1200C-3FTN256C	1200	1.8V/2.5V/3.3V	211	-3	Lead-Free ftBGA	256	COM
LCMXO1200C-4FTN256C	1200	1.8V/2.5V/3.3V	211	-4	Lead-Free ftBGA	256	COM
LCMXO1200C-5FTN256C	1200	1.8V/2.5V/3.3V	211	-5	Lead-Free ftBGA	256	COM





Part Number	LUTs	Supply Voltage	I/Os	Grade	Package	Pins	Temp.
LCMXO1200E-3TN100C	1200	1.2V	73	-3	Lead-Free TQFP	100	COM
LCMXO1200E-4TN100C	1200	1.2V	73	-4	Lead-Free TQFP	100	COM
LCMXO1200E-5TN100C	1200	1.2V	73	-5	Lead-Free TQFP	100	COM
LCMXO1200E-3TN144C	1200	1.2V	113	-3	Lead-Free TQFP	144	COM
LCMXO1200E-4TN144C	1200	1.2V	113	-4	Lead-Free TQFP	144	COM
LCMXO1200E-5TN144C	1200	1.2V	113	-5	Lead-Free TQFP	144	COM
LCMXO1200E-3MN132C	1200	1.2V	101	-3	Lead-Free csBGA	132	COM
LCMXO1200E-4MN132C	1200	1.2V	101	-4	Lead-Free csBGA	132	COM
LCMXO1200E-5MN132C	1200	1.2V	101	-5	Lead-Free csBGA	132	COM
LCMXO1200E-3BN256C	1200	1.2V	211	-3	Lead-Free caBGA	256	COM
LCMXO1200E-4BN256C	1200	1.2V	211	-4	Lead-Free caBGA	256	COM
LCMXO1200E-5BN256C	1200	1.2V	211	-5	Lead-Free caBGA	256	COM
LCMXO1200E-3FTN256C	1200	1.2V	211	-3	Lead-Free ftBGA	256	COM
LCMXO1200E-4FTN256C	1200	1.2V	211	-4	Lead-Free ftBGA	256	COM
LCMXO1200E-5FTN256C	1200	1.2V	211	-5	Lead-Free ftBGA	256	COM

Part Number	LUTs	Supply Voltage	I/Os	Grade	Package	Pins	Temp.
LCMXO2280E-3TN100C	2280	1.2V	73	-3	Lead-Free TQFP	100	COM
LCMXO2280E-4TN100C	2280	1.2V	73	-4	Lead-Free TQFP	100	COM
LCMXO2280E-5TN100C	2280	1.2V	73	-5	Lead-Free TQFP	100	COM
LCMXO2280E-3TN144C	2280	1.2V	113	-3	Lead-Free TQFP	144	COM
LCMXO2280E-4TN144C	2280	1.2V	113	-4	Lead-Free TQFP	144	COM
LCMXO2280E-5TN144C	2280	1.2V	113	-5	Lead-Free TQFP	144	COM
LCMXO2280E-3MN132C	2280	1.2V	101	-3	Lead-Free csBGA	132	COM
LCMXO2280E-4MN132C	2280	1.2V	101	-4	Lead-Free csBGA	132	COM
LCMXO2280E-5MN132C	2280	1.2V	101	-5	Lead-Free csBGA	132	COM
LCMXO2280E-3BN256C	2280	1.2V	211	-3	Lead-Free caBGA	256	COM
LCMXO2280E-4BN256C	2280	1.2V	211	-4	Lead-Free caBGA	256	COM
LCMXO2280E-5BN256C	2280	1.2V	211	-5	Lead-Free caBGA	256	COM
LCMXO2280E-3FTN256C	2280	1.2V	211	-3	Lead-Free ftBGA	256	COM
LCMXO2280E-4FTN256C	2280	1.2V	211	-4	Lead-Free ftBGA	256	COM
LCMXO2280E-5FTN256C	2280	1.2V	211	-5	Lead-Free ftBGA	256	COM
LCMXO2280E-3FTN324C	2280	1.2V	271	-3	Lead-Free ftBGA	324	COM
LCMXO2280E-4FTN324C	2280	1.2V	271	-4	Lead-Free ftBGA	324	COM
LCMXO2280E-5FTN324C	2280	1.2V	271	-5	Lead-Free ftBGA	324	COM